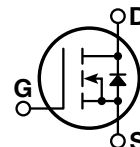


## POWER MOS 7® MOSFET

Power MOS 7® is a new generation of low loss, high voltage, N-Channel enhancement mode power MOSFETS. Both conduction and switching losses are addressed with Power MOS 7® by significantly lowering  $R_{DS(ON)}$  and  $Q_g$ . Power MOS 7® combines lower conduction and switching losses along with exceptionally fast switching speeds inherent with APT's patented metal gate structure.



- Lower Input Capacitance
- Lower Miller Capacitance
- Lower Gate Charge,  $Q_g$
- Increased Power Dissipation
- Easier To Drive
- Popular SOT-227 Package



### MAXIMUM RATINGS

All Ratings:  $T_C = 25^\circ\text{C}$  unless otherwise specified.

| Symbol         | Parameter                                                      | APT60M75JLL | UNIT                |
|----------------|----------------------------------------------------------------|-------------|---------------------|
| $V_{DSS}$      | Drain-Source Voltage                                           | 600         | Volts               |
| $I_D$          | Continuous Drain Current @ $T_C = 25^\circ\text{C}$            | 58          | Amps                |
| $I_{DM}$       | Pulsed Drain Current <sup>①</sup>                              | 232         |                     |
| $V_{GS}$       | Gate-Source Voltage Continuous                                 | $\pm 30$    | Volts               |
| $V_{GSM}$      | Gate-Source Voltage Transient                                  | $\pm 40$    |                     |
| $P_D$          | Total Power Dissipation @ $T_C = 25^\circ\text{C}$             | 595         | Watts               |
|                | Linear Derating Factor                                         | 4.76        | W/ $^\circ\text{C}$ |
| $T_J, T_{STG}$ | Operating and Storage Junction Temperature Range               | -55 to 150  | $^\circ\text{C}$    |
| $T_L$          | Lead Temperature: 0.063" from Case for 10 Sec.                 | 300         |                     |
| $I_{AR}$       | Avalanche Current <sup>①</sup> (Repetitive and Non-Repetitive) | 58          | Amps                |
| $E_{AR}$       | Repetitive Avalanche Energy <sup>①</sup>                       | 50          | mJ                  |
| $E_{AS}$       | Single Pulse Avalanche Energy <sup>④</sup>                     | 3200        |                     |

### STATIC ELECTRICAL CHARACTERISTICS

| Symbol       | Characteristic / Test Conditions                                                          | MIN | TYP | MAX       | UNIT    |
|--------------|-------------------------------------------------------------------------------------------|-----|-----|-----------|---------|
| $BV_{DSS}$   | Drain-Source Breakdown Voltage ( $V_{GS} = 0V, I_D = 250\mu A$ )                          | 600 |     |           | Volts   |
| $R_{DS(on)}$ | Drain-Source On-State Resistance <sup>②</sup> ( $V_{GS} = 10V, I_D = 29A$ )               |     |     | 0.075     | Ohms    |
| $I_{DSS}$    | Zero Gate Voltage Drain Current ( $V_{DS} = 600V, V_{GS} = 0V$ )                          |     |     | 100       | $\mu A$ |
|              | Zero Gate Voltage Drain Current ( $V_{DS} = 480V, V_{GS} = 0V, T_C = 125^\circ\text{C}$ ) |     |     | 500       |         |
| $I_{GSS}$    | Gate-Source Leakage Current ( $V_{GS} = \pm 30V, V_{DS} = 0V$ )                           |     |     | $\pm 100$ | nA      |
| $V_{GS(th)}$ | Gate Threshold Voltage ( $V_{DS} = V_{GS}, I_D = 5mA$ )                                   | 3   |     | 5         | Volts   |



**CAUTION:** These Devices are Sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

APT Website - <http://www.advancedpower.com>

# DYNAMIC CHARACTERISTICS

APT60M75JLL

| Symbol       | Characteristic               | Test Conditions                                                                                                  | MIN | TYP  | MAX | UNIT    |
|--------------|------------------------------|------------------------------------------------------------------------------------------------------------------|-----|------|-----|---------|
| $C_{iss}$    | Input Capacitance            | $V_{GS} = 0V$<br>$V_{DS} = 25V$<br>$f = 1\text{ MHz}$                                                            |     | 8930 |     | pF      |
| $C_{oss}$    | Output Capacitance           |                                                                                                                  |     | 1130 |     |         |
| $C_{rss}$    | Reverse Transfer Capacitance |                                                                                                                  |     | 50   |     |         |
| $Q_g$        | Total Gate Charge ③          | $V_{GS} = 10V$<br>$V_{DD} = 300V$<br>$I_D = 58A @ 25^\circ C$                                                    |     | 195  |     | nC      |
| $Q_{gs}$     | Gate-Source Charge           |                                                                                                                  |     | 48   |     |         |
| $Q_{gd}$     | Gate-Drain ("Miller") Charge |                                                                                                                  |     | 100  |     |         |
| $t_{d(on)}$  | Turn-on Delay Time           | <b>RESISTIVE SWITCHING</b><br>$V_{GS} = 15V$<br>$V_{DD} = 300V$<br>$I_D = 58A @ 25^\circ C$<br>$R_G = 0.6\Omega$ |     | 23   |     | ns      |
| $t_r$        | Rise Time                    |                                                                                                                  |     | 15   |     |         |
| $t_{d(off)}$ | Turn-off Delay Time          |                                                                                                                  |     | 55   |     |         |
| $t_f$        | Fall Time                    |                                                                                                                  |     | 10   |     |         |
| $E_{on}$     | Turn-on Switching Energy ⑥   | <b>INDUCTIVE SWITCHING @ 25°C</b><br>$V_{DD} = 400V, V_{GS} = 15V$<br>$I_D = 58A, R_G = 5\Omega$                 |     | 1205 |     | $\mu J$ |
| $E_{off}$    | Turn-off Switching Energy    |                                                                                                                  |     | 1385 |     |         |
| $E_{on}$     | Turn-on Switching Energy ⑥   | <b>INDUCTIVE SWITCHING @ 125°C</b><br>$V_{DD} = 400V, V_{GS} = 15V$<br>$I_D = 58A, R_G = 5\Omega$                |     | 1865 |     |         |
| $E_{off}$    | Turn-off Switching Energy    |                                                                                                                  |     | 1550 |     |         |

# SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS

| Symbol   | Characteristic / Test Conditions                               | MIN | TYP | MAX | UNIT    |
|----------|----------------------------------------------------------------|-----|-----|-----|---------|
| $I_S$    | Continuous Source Current (Body Diode)                         |     |     | 58  | Amps    |
| $I_{SM}$ | Pulsed Source Current ① (Body Diode)                           |     |     | 232 |         |
| $V_{SD}$ | Diode Forward Voltage ② ( $V_{GS} = 0V, I_S = -58A$ )          |     |     | 1.3 | Volts   |
| $t_{rr}$ | Reverse Recovery Time ( $I_S = -58A, di_S/dt = 100A/\mu s$ )   |     | 857 |     | ns      |
| $Q_{rr}$ | Reverse Recovery Charge ( $I_S = -58A, di_S/dt = 100A/\mu s$ ) |     | 26  |     | $\mu C$ |
| $dv/dt$  | Peak Diode Recovery $dv/dt$ ⑤                                  |     |     | 8   | V/ns    |

# THERMAL CHARACTERISTICS

| Symbol          | Characteristic      | MIN | TYP | MAX  | UNIT         |
|-----------------|---------------------|-----|-----|------|--------------|
| $R_{\theta JC}$ | Junction to Case    |     |     | 0.21 | $^\circ C/W$ |
| $R_{\theta JA}$ | Junction to Ambient |     |     | 40   |              |

① Repetitive Rating: Pulse width limited by maximum junction temperature

② Pulse Test: Pulse width < 380  $\mu s$ , Duty Cycle < 2%

③ See MIL-STD-750 Method 3471

④ Starting  $T_J = +25^\circ C$ ,  $L = 1.90mH$ ,  $R_G = 25\Omega$ , Peak  $I_L = 58A$

⑤  $dv/dt$  numbers reflect the limitations of the test circuit rather than the device itself.  $I_S \leq -I_{D58A}$   $di/dt \leq 700A/\mu s$   $V_R \leq 600V$   $T_J \leq 150^\circ C$

⑥  $E_{on}$  includes diode reverse recovery. See figures 18, 20.

APT Reserves the right to change, without notice, the specifications and information contained herein.

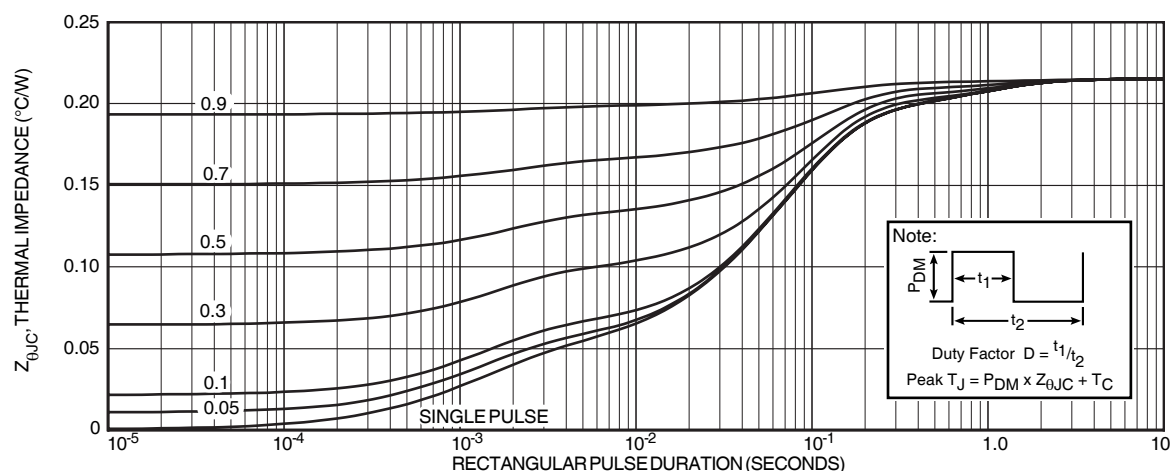


FIGURE 1, MAXIMUM EFFECTIVE TRANSIENT THERMAL IMPEDANCE, JUNCTION-TO-CASE vs PULSE DURATION

# Typical Performance Curves

APT60M75JLL

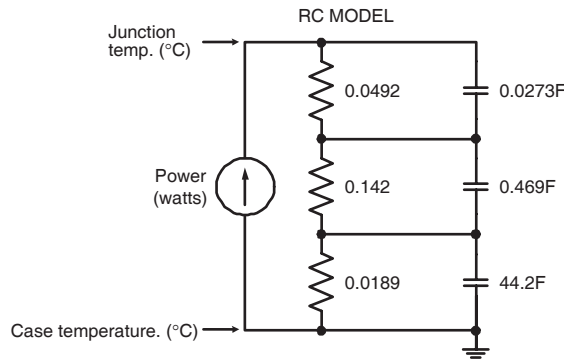


FIGURE2, TRANSIENT THERMAL IMPEDANCE MODEL

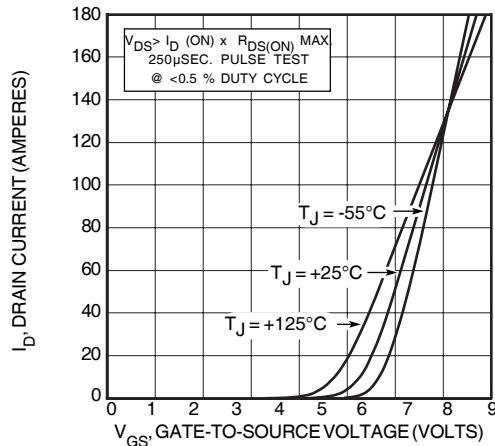


FIGURE4, TRANSFER CHARACTERISTICS

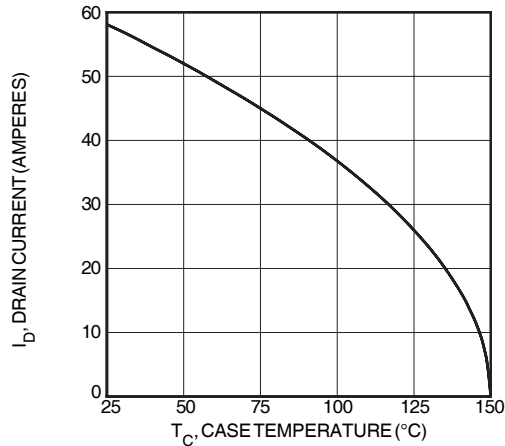


FIGURE6, MAXIMUM DRAIN CURRENT vs CASE TEMPERATURE

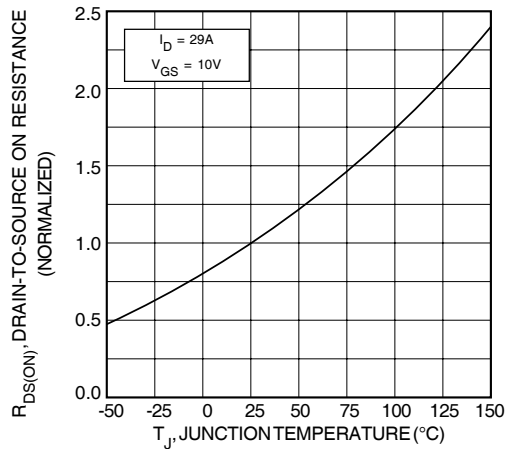


FIGURE8,  $R_{DS(ON)}$  vs. TEMPERATURE

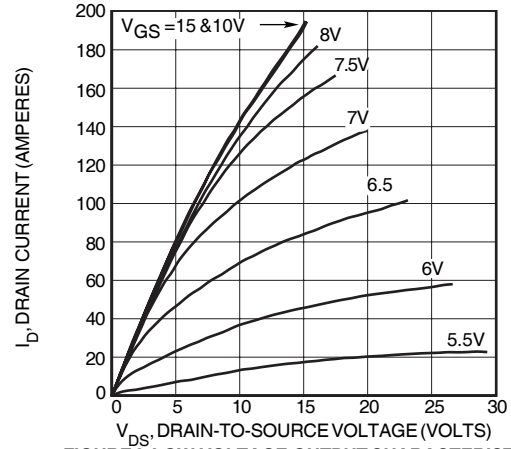


FIGURE3, LOW VOLTAGE OUTPUT CHARACTERISTICS

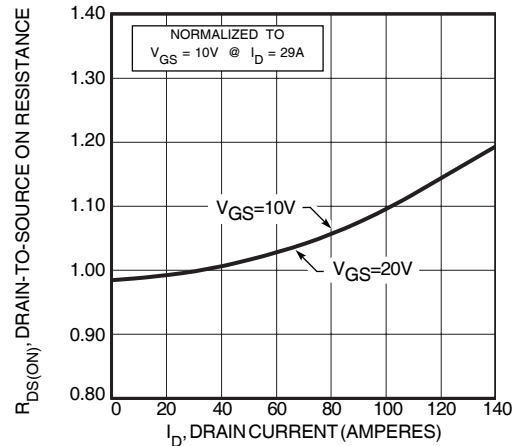


FIGURE5,  $R_{DS(ON)}$  vs DRAIN CURRENT

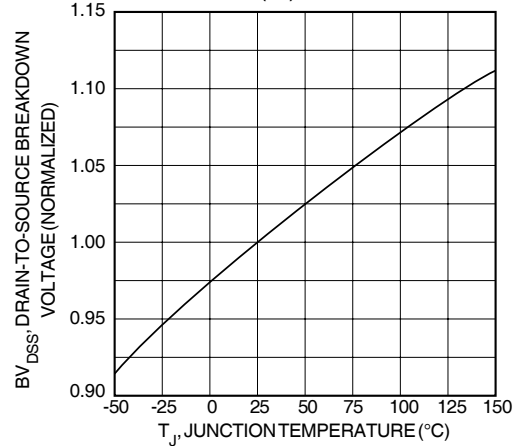


FIGURE7, BREAKDOWN VOLTAGE vs TEMPERATURE

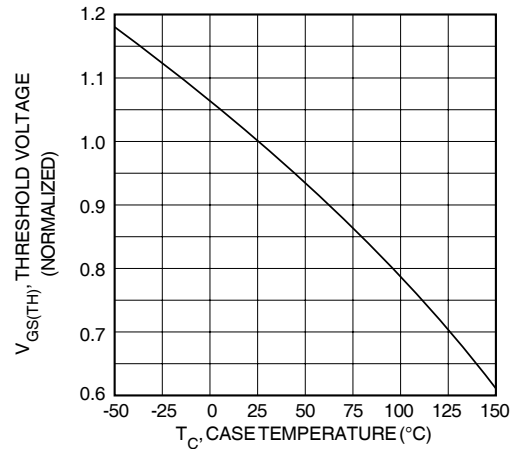


FIGURE9, THRESHOLD VOLTAGE vs TEMPERATURE

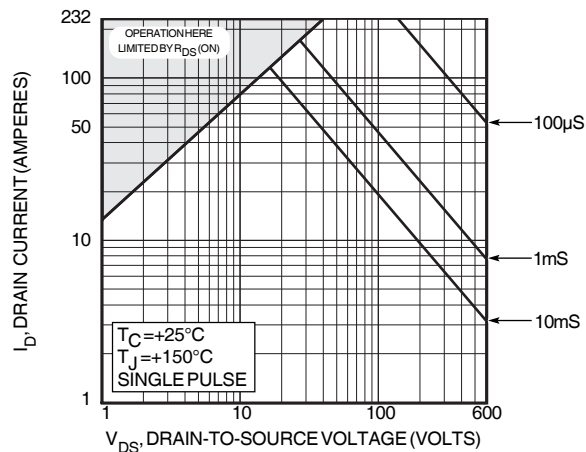


FIGURE 10, MAXIMUM SAFE OPERATING AREA

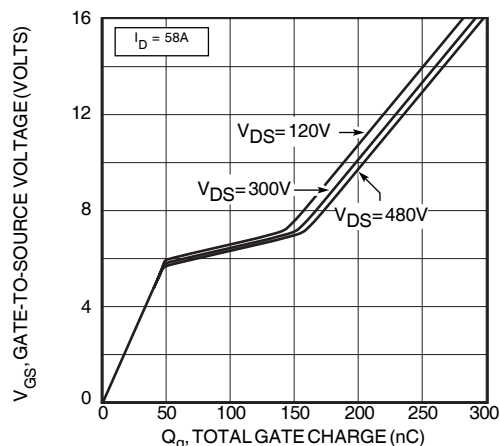


FIGURE 12, GATE CHARGE vs GATE-TO-SOURCE VOLTAGE

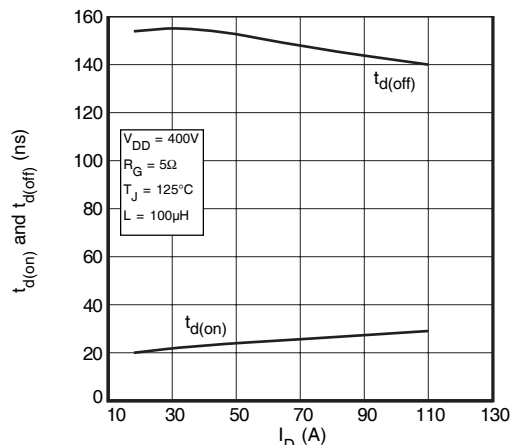


FIGURE 14, DELAY TIMES vs CURRENT

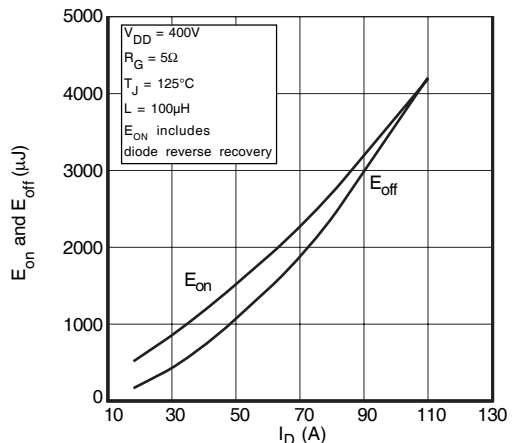


FIGURE 16, SWITCHING ENERGY vs CURRENT

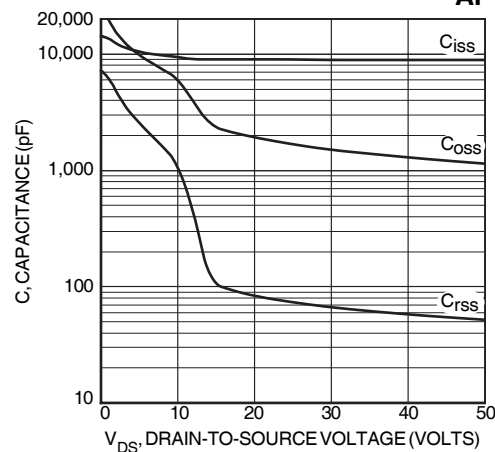


FIGURE 11, CAPACITANCE vs DRAIN-TO-SOURCE VOLTAGE

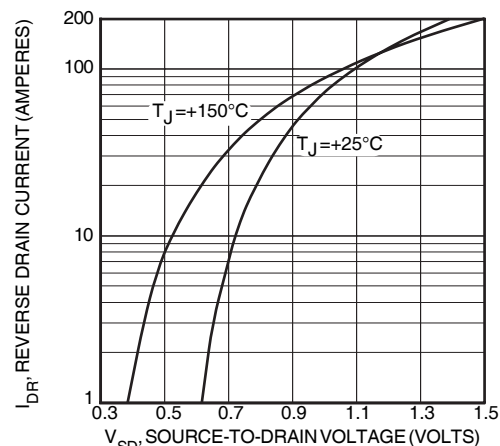


FIGURE 13, SOURCE-DRAIN DIODE FORWARD VOLTAGE

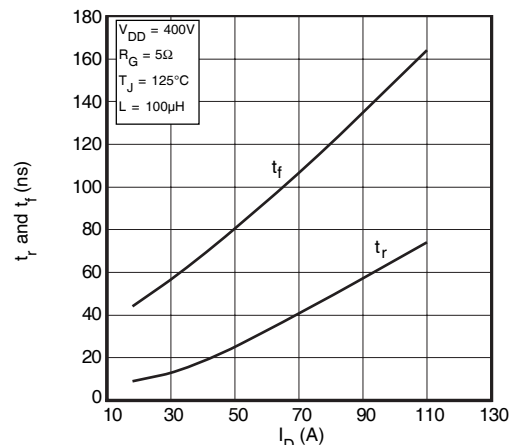


FIGURE 15, RISE AND FALL TIMES vs CURRENT

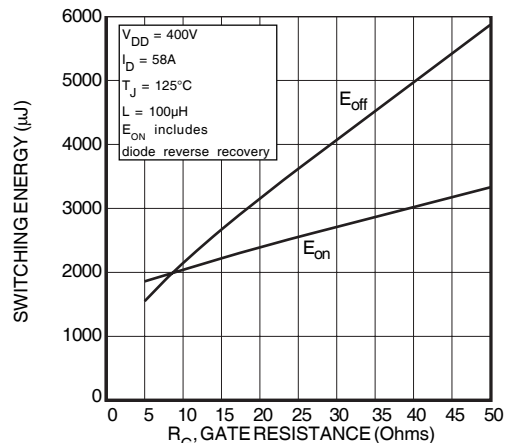


FIGURE 17, SWITCHING ENERGY vs. GATE RESISTANCE

The diagram shows a MOSFET circuit. A DC voltage source  $V_{DD}$  is connected to the drain of the MOSFET through a load inductor. A diode, labeled APT60DF60, is connected in parallel with the inductor, with its cathode towards the drain. The MOSFET's gate is connected to a gate voltage source  $V_{GS}$  (represented by a battery symbol). The drain current is labeled  $I_D$  and the drain-source voltage is labeled  $V_{DS}$ . The MOSFET is labeled D.U.T. (Device Under Test). The source of the MOSFET is connected to ground.

**Top View Dimensions:**

- Overall width: 31.5 (.1240), 31.7 (1.248)
- Pin spacing: 7.8 (.307), 8.2 (.322)
- Mounting hole diameter: 4.0 (.157) (2 places), 4.2 (.165) (2 places)
- Gate width: 4.1 (.161), 4.3 (.169)
- Drain width: 4.8 (.187), 4.9 (.193)
- Gate/Drain pattern: 4 places
- Pin diameter: 14.9 (.587), 15.1 (.594)
- Pin spacing: 30.1 (1.185), 30.3 (1.193)
- Overall pin width: 38.0 (1.496), 38.2 (1.504)

**Side View Dimensions:**

- Package height: 11.8 (.463), 12.2 (.480)
- Mounting hole diameter: 8.9 (.350), 9.6 (.378)
- Lead height: 1.95 (.077), 2.14 (.084)
- Lead width: 0.75 (.030), 0.85 (.033)
- Lead spacing: 12.6 (.496), 12.8 (.504)
- Overall lead width: 25.2 (0.992), 25.4 (1.000)

**Detail View:**

- Source terminals are shorted internally.
- Current handling capability is equal for either Source terminal.

ISOTOP® is a Registered Trademark of SGS Thomson. APT's products are covered by one or more of U.S. patents 4,895,810 5,045,903 5,089,434 5,182,234 5,019,522 5,262,336 6,503,786 5,256,583 4,748,103 5,283,202 5,231,474 5,434,095 5,528,058 and foreign patents. US and Foreign patents pending. All Rights Reserved.



**Стандарт  
Электрон  
Связь**

Мы молодая и активно развивающаяся компания в области поставок электронных компонентов. Мы поставляем электронные компоненты отечественного и импортного производства напрямую от производителей и с крупнейших складов мира.

Благодаря сотрудничеству с мировыми поставщиками мы осуществляем комплексные и плановые поставки широчайшего спектра электронных компонентов.

Собственная эффективная логистика и склад в обеспечивает надежную поставку продукции в точно указанные сроки по всей России.

Мы осуществляем техническую поддержку нашим клиентам и предпродажную проверку качества продукции. На все поставляемые продукты мы предоставляем гарантию .

Осуществляем поставки продукции под контролем ВП МО РФ на предприятия военно-промышленного комплекса России , а также работаем в рамках 275 ФЗ с открытием отдельных счетов в уполномоченном банке. Система менеджмента качества компании соответствует требованиям ГОСТ ISO 9001.

Минимальные сроки поставки, гибкие цены, неограниченный ассортимент и индивидуальный подход к клиентам являются основой для выстраивания долгосрочного и эффективного сотрудничества с предприятиями радиоэлектронной промышленности, предприятиями ВПК и научно-исследовательскими институтами России.

С нами вы становитесь еще успешнее!

**Наши контакты:**

**Телефон:** +7 812 627 14 35

**Электронная почта:** [sales@st-electron.ru](mailto:sales@st-electron.ru)

**Адрес:** 198099, Санкт-Петербург,  
Промышленная ул, дом № 19, литера Н,  
помещение 100-Н Офис 331